



Product Change Notification

Change Notification #: 115125-00
Change Title: Intel® Server Kit A2U44X25NVMEDK2, PCN 115125-00, Product Design, Product Material, System RoHS compliance exemption free conversion update and Firmware update.

Date of Publication: November 28, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 2, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server kit A2U44X25NVMEDK2:

1. Replacement of components containing substances listed under EU RoHS exemption 6(c), 7(c) and 15 with exemption free versions. All new components are identical in form factor and function to the replaced ones.

Components containing substances listed under EU RoHS exemption 7(a) are not affected with the exception of one IC.

2. Update of the System Firmware installed on the systems that support the kit A2U44X25NVMEDK2:
 - a. Update the BIOS from revision R01.01.0014 to revision R01.01.0016.
 - b. Update the Manageability Engine (ME) firmware from revision 03.01.03.005 to revision 03.01.03.021.
 - c. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 1.13.8932 to revision 01.43.9685.
 - d. Update the FRUSDR from revision 1.11 to revision 1.13
 - e. PSOC update from 1.12 to 1.19 on HSBPs
3. Remove J26 programming connector from the Hot-Swap Back Plane.

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
A2U44X25NVMEDK2	947924	J11462-001	J11462-002

PCN Revision History:

Date of Revision:

November 28, 2016

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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